

## QIAOXIN N-Channel Enhancement Mode Power MOSFET

**Description**

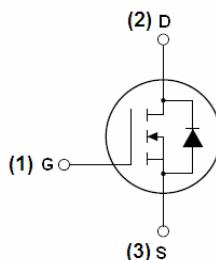
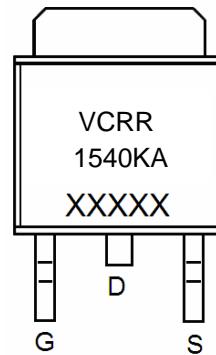
The VCRR1540KA uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

**General Features**

- $V_{DS} = 150V, I_D = 40A$
- $R_{DS(ON)} < 45m\Omega @ V_{GS}=10V$  (Typ:35m $\Omega$ )
- High density cell design for ultra low  $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

**Application**

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

**Schematic diagram****Marking and pin assignment****TO-252-2L top view****Package Marking and Ordering Information**

| Device Marking | Device     | Device Package | Reel Size | Tape width | Quantity |
|----------------|------------|----------------|-----------|------------|----------|
| VCRR1540KA     | VCRR1540KA | TO-252-2L      | -         | -          | -        |

**Absolute Maximum Ratings ( $T_C=25^\circ C$  unless otherwise noted)**

| Parameter   | Symbol             | Limit      | Unit          |
|---|--------------------|------------|---------------|
| Drain-Source Voltage                              | $V_{DS}$           | 150        | V             |
| Gate-Source Voltage                               | $V_{GS}$           | $\pm 12$   | V             |
| Drain Current-Continuous                          | $I_D$              | 40         | A             |
| Drain Current-Continuous( $T_C=100^\circ C$ )     | $I_D(100^\circ C)$ | 29         | A             |
| Pulsed Drain Current                              | $I_{DM}$           | 160        | A             |
| Maximum Power Dissipation                         | $P_D$              | 140        | W             |
| Derating factor                                   |                    | 0.93       | W/ $^\circ C$ |
| Single pulse avalanche energy <sup>(Note 5)</sup> | $E_{AS}$           | 350        | mJ            |
| Operating Junction and Storage Temperature Range  | $T_J, T_{STG}$     | -55 To 175 | $^\circ C$    |

### Thermal Characteristic

|  |                  |      |      |
|--|------------------|------|------|
| Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup> | R <sub>θJC</sub> | 1.07 | °C/W |
|--|------------------|------|------|

### Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

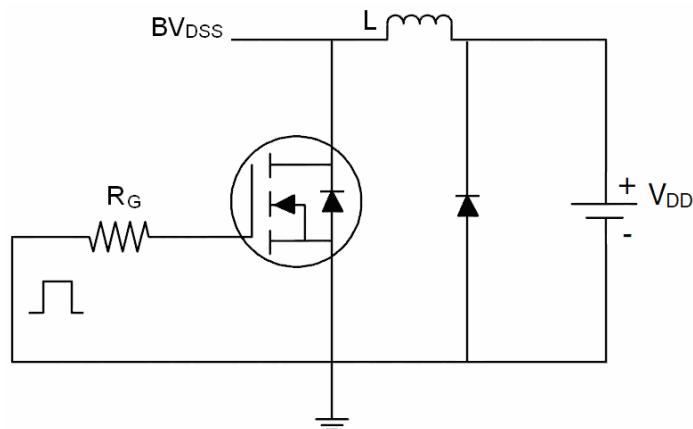
| Parameter  | Symbol              | Condition   | Min | Typ  | Max  | Unit |
|--|---------------------|---|-----|------|------|------|
| <b>Off Characteristics</b>                           |                     |   |     |      |      |      |
| Drain-Source Breakdown Voltage                       | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250μA   | 150 | -    | -    | V    |
| Zero Gate Voltage Drain Current                      | I <sub>DSS</sub>    | V <sub>DS</sub> =150V, V <sub>GS</sub> =0V  | -   | -    | 1    | μA   |
| Gate-Body Leakage Current                            | I <sub>GSS</sub>    | V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V  | -   | -    | ±100 | nA   |
| <b>On Characteristics</b> <sup>(Note 3)</sup>        |                     |   |     |      |      |      |
| Gate Threshold Voltage                               | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA  | 0.7 | 1.05 | 1.4  | V    |
| Drain-Source On-State Resistance                     | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =18A   | -   | 35   | 45   | mΩ   |
| Forward Transconductance                             | g <sub>FS</sub>     | V <sub>DS</sub> =5V, I <sub>D</sub> =18A  | 38  | -    | -    | S    |
| <b>Dynamic Characteristics</b> <sup>(Note 4)</sup>   |                     |   |     |      |      |      |
| Input Capacitance                                    | C <sub>iss</sub>    | V <sub>DS</sub> =75V, V <sub>GS</sub> =0V,<br>F=1.0MHz  | -   | 4300 | -    | PF   |
| Output Capacitance                                   | C <sub>oss</sub>    |   | -   | 130  | -    | PF   |
| Reverse Transfer Capacitance                         | C <sub>rss</sub>    |   | -   | 111  | -    | PF   |
| <b>Switching Characteristics</b> <sup>(Note 4)</sup> |                     |   |     |      |      |      |
| Turn-on Delay Time                                   | t <sub>d(on)</sub>  | V <sub>DD</sub> =30V, I <sub>D</sub> =2A, R <sub>L</sub> =15Ω<br>V <sub>GS</sub> =10V, R <sub>G</sub> =2.5Ω | -   | 14   | -    | nS   |
| Turn-on Rise Time                                    | t <sub>r</sub>      |   | -   | 12   | -    | nS   |
| Turn-Off Delay Time                                  | t <sub>d(off)</sub> |   | -   | 45   | -    | nS   |
| Turn-Off Fall Time                                   | t <sub>f</sub>      |   | -   | 11   | -    | nS   |
| Total Gate Charge                                    | Q <sub>g</sub>      | V <sub>DS</sub> =75V, I <sub>D</sub> =18A,<br>V <sub>GS</sub> =4.5V   |     | 63.8 | -    | nC   |
| Gate-Source Charge                                   | Q <sub>gs</sub>     |   |     | 9.8  | -    | nC   |
| Gate-Drain Charge                                    | Q <sub>gd</sub>     |   |     | 26.9 | -    | nC   |
| <b>Drain-Source Diode Characteristics</b>            |                     |   |     |      |      |      |
| Diode Forward Voltage <sup>(Note 3)</sup>            | V <sub>SD</sub>     | V <sub>GS</sub> =0V, I <sub>S</sub> =18A  | -   | -    | 1.2  | V    |
| Diode Forward Current <sup>(Note 2)</sup>            | I <sub>S</sub>      |   | -   | -    | 40   | A    |
| Reverse Recovery Time                                | t <sub>rr</sub>     | T <sub>J</sub> = 25°C, IF = 18A<br>di/dt = 100A/μs <sup>(Note 3)</sup>                                      | -   | 42   | -    | nS   |
| Reverse Recovery Charge                              | Q <sub>rr</sub>     |   | -   | 75   | -    | nC   |

### Notes:

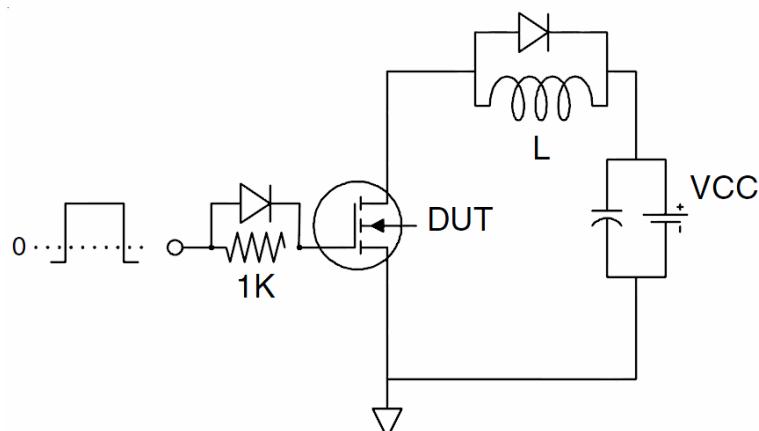
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. EAS condition: T<sub>j</sub>=25°C, V<sub>DD</sub>=50V, V<sub>G</sub>=10V, L=0.5mH, R<sub>g</sub>=25Ω

## Test Circuit

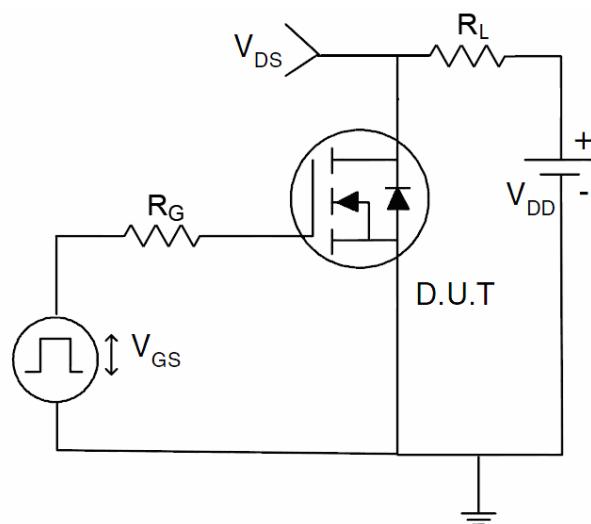
### 1) E<sub>AS</sub> test Circuit



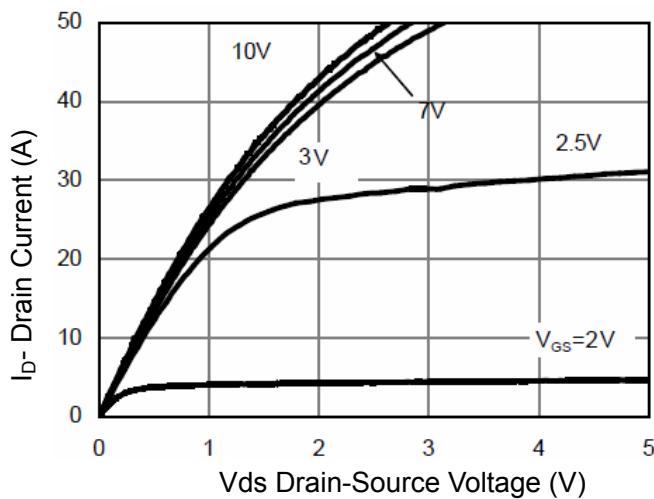
### 2) Gate charge test Circuit



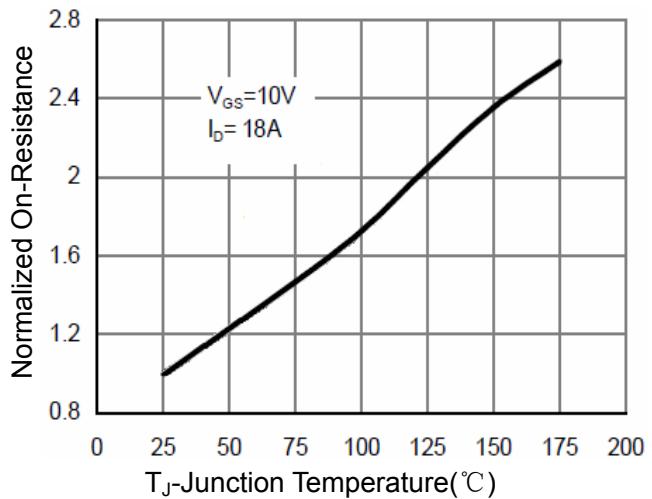
### 3) Switch Time Test Circuit:



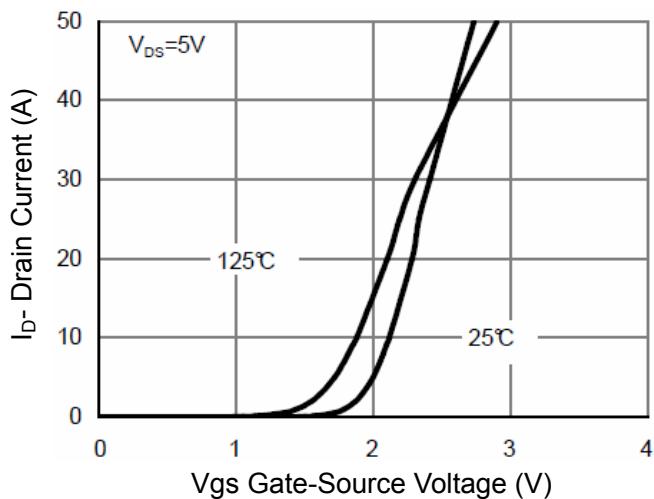
## Typical Electrical and Thermal Characteristics (Curves)



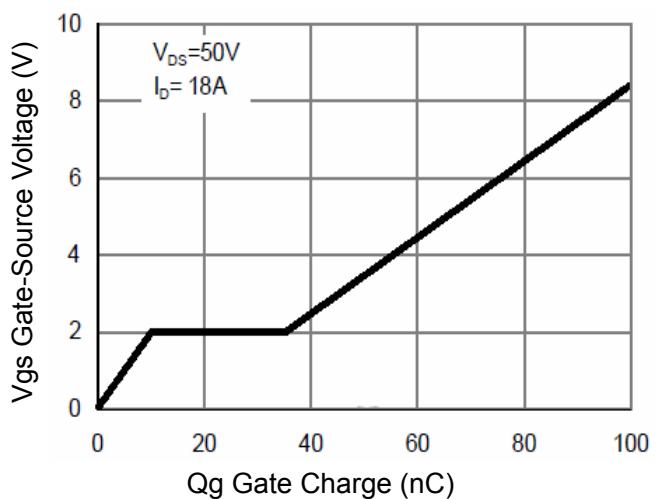
**Figure 1 Output Characteristics**



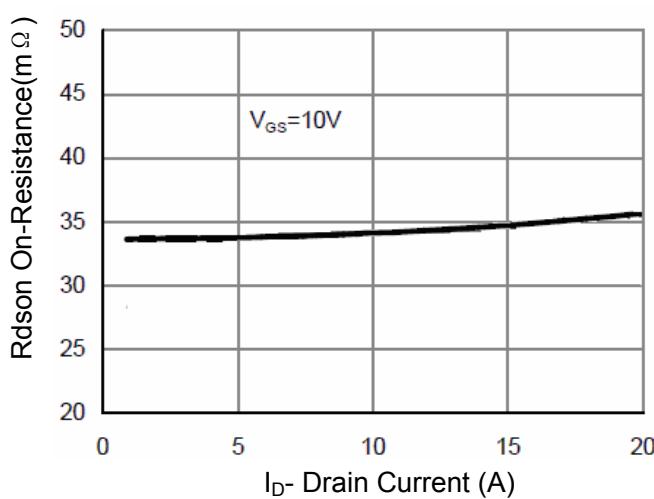
**Figure 4  $R_{DS(on)}$ -Junction Temperature**



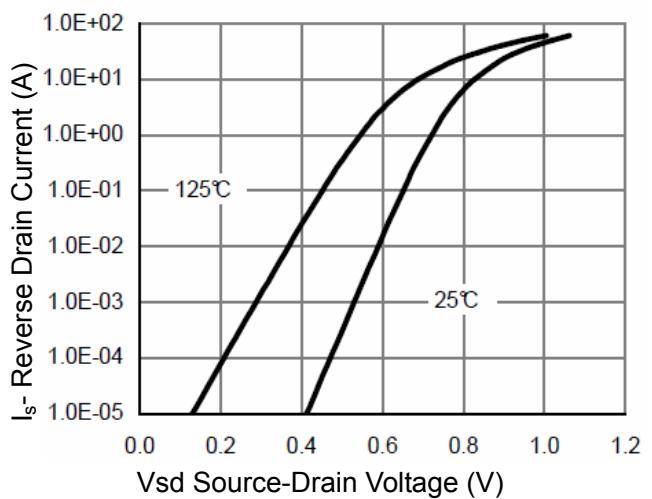
**Figure 2 Transfer Characteristics**



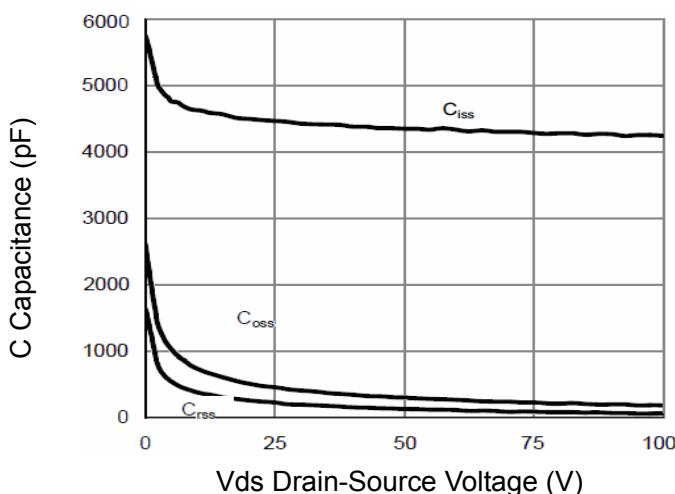
**Figure 5 Gate Charge**



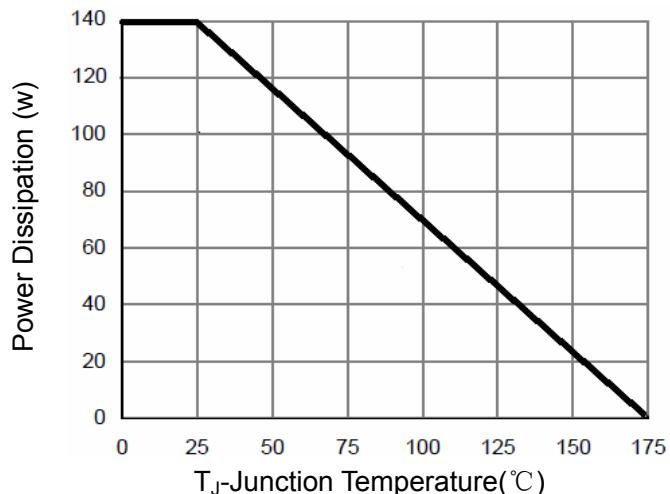
**Figure 3  $R_{DS(on)}$ - Drain Current**



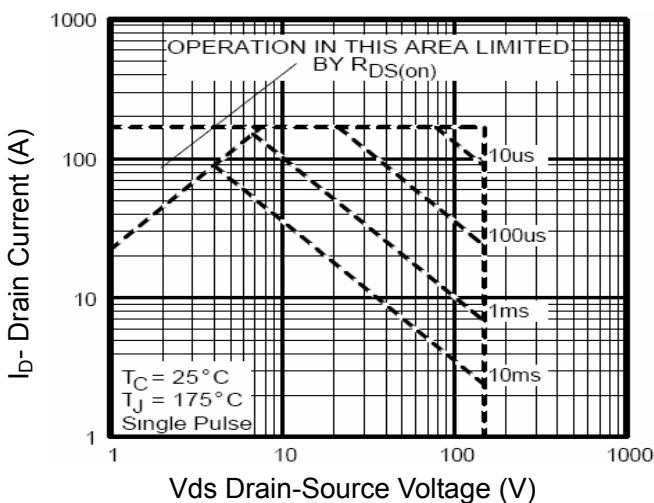
**Figure 6 Source-Drain Diode Forward**



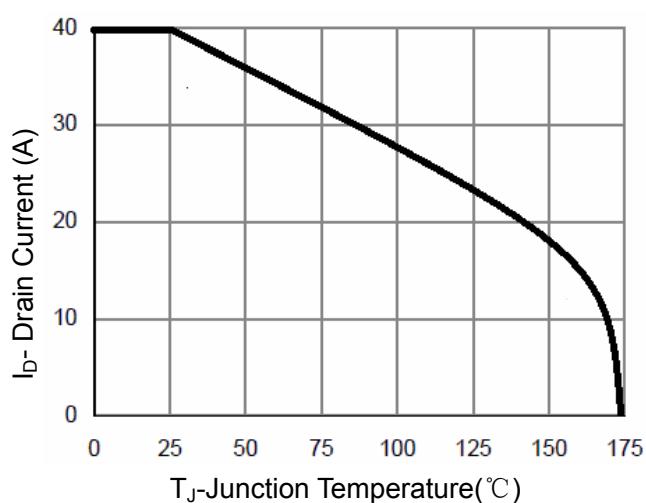
**Figure 7 Capacitance vs Vds**



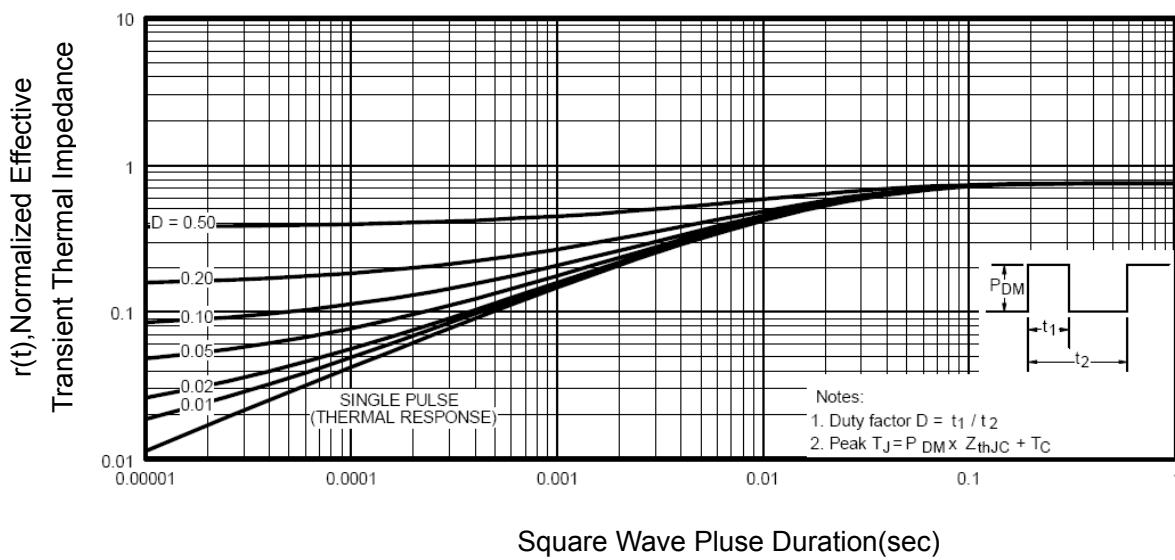
**Figure 9 Power De-rating**



**Figure 8 Safe Operation Area**

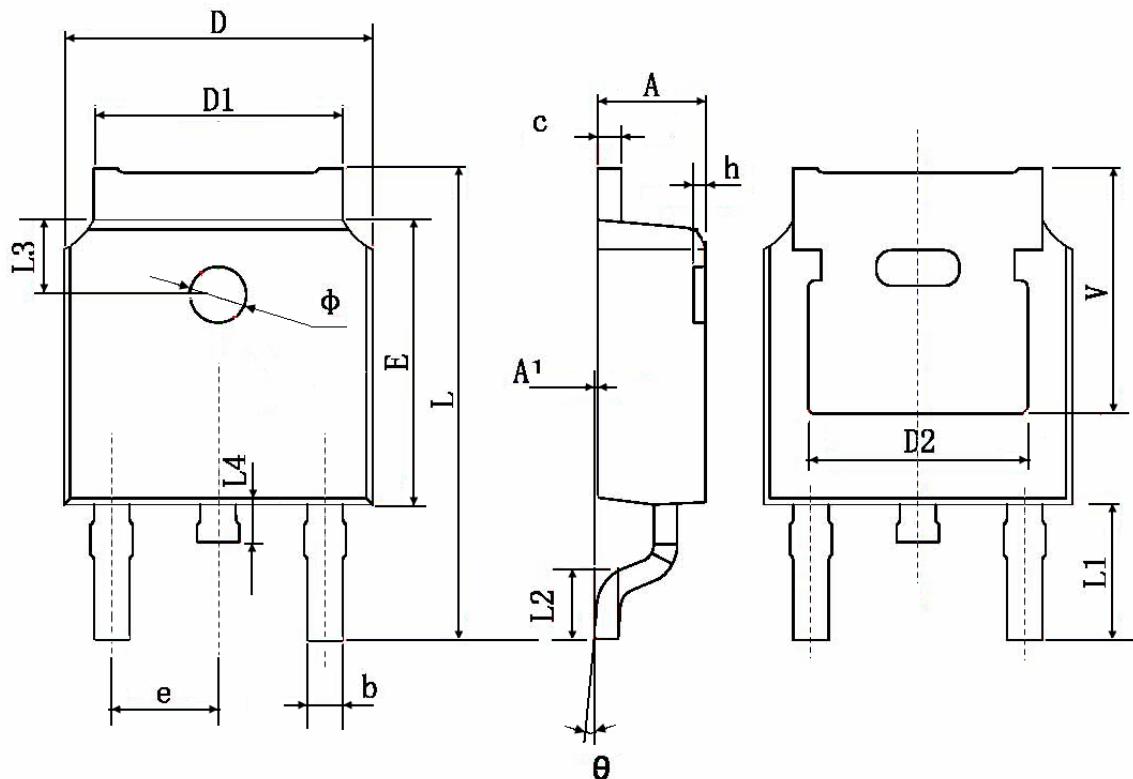


**Figure 10 Current De-rating**



**Figure 11 Normalized Maximum Transient Thermal Impedance**

## TO-252 Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 2.200                     | 2.400  | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127  | 0.000                | 0.005 |
| b      | 0.660                     | 0.860  | 0.026                | 0.034 |
| c      | 0.460                     | 0.580  | 0.018                | 0.023 |
| D      | 6.500                     | 6.700  | 0.256                | 0.264 |
| D1     | 5.100                     | 5.460  | 0.201                | 0.215 |
| D2     | 4.830TYP.                 |        | 0.190 TYP.           |       |
| E      | 6.000                     | 6.200  | 0.236                | 0.244 |
| e      | 2.186                     | 2.386  | 0.086                | 0.094 |
| L      | 9.800                     | 10.400 | 0.386                | 0.409 |
| L1     | 2.900 TYP.                |        | 0.114 TYP.           |       |
| L2     | 1.400                     | 1.700  | 0.055                | 0.067 |
| L3     | 1.600 TYP.                |        | 0.063 TYP.           |       |
| L4     | 0.600                     | 1.000  | 0.024                | 0.039 |
| Φ      | 1.100                     | 1.300  | 0.043                | 0.051 |
| θ      | 0°                        | 8°     | 0°                   | 8°    |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |
| V      | 5.350 TYP.                |        | 0.211 TYP.           |       |

### **Attention**

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